



Customer Information Notification

202406019I : Rectification on SE050 Configuration Datasheet AN12436 with Regards to Power Down Mode Availability on Released Products

Note: This notice is NXP Company Proprietary.

Issue Date: Jul 12, 2024 **Effective Date:** Jul 13, 2024

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Management summary

Configuration datasheet correction to reflect power down mode availability on released products. The power down mode is not available by default in all released SE050 configurations. The configuration datasheet AN12436 did not reflect properly this setting. Hence the AN12436 has been updated accordingly.

Configuration Datasheet link: <https://www.nxp.com/docs/en/application-note/AN12436.pdf>

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Process | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Location | <input type="checkbox"/> Electrical spec./Test coverage |
- Firmware Other: Documentations - Configuration Datasheet

Notification Overview

Description

- The AN12436 has been updated indicating which one of the Ease of Use SE050 released variants may support the power down mode. The new version of this document is 2.4.

Reason

The configuration datasheet did not reflect properly the availability of the power down mode on the released SE050 configurations.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

No change on the product itself.

However, power down mode may not be available on released variants as wrongly described in previous versions of product documentation.

If power down mode was not used nor planned to be used by customers, there is no impact.

Data Sheet Revision

No impact to existing data sheet

Disposition of Old Products

No action on products. Only documentation change.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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